



Specification for Approval

- DEVICE NUMBER: BL-BST204

| |
|----------------------------------|
| SAMPLES ATTACHED AREA |
|----------------------------------|

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|-------------|-----|-----|-----|-----|--|--|--|--|--|--|--|-------------------|
| 2015/10/10 | 1.0 | 1.0 | 1.0 | 1.0 | | | | | | | | Original Released |
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FOR CUSTOMER'S APPROVAL STAMP OR SIGNATURE

| APPROVED | PURCHASE | MANUFACTURE | QUALITY | ENGINEERING |
|----------|----------|-------------|---------|-------------|
| | | | | |

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| ISSUED | APPROVED | PREPARED |
|--------|----------|----------|
| | | |

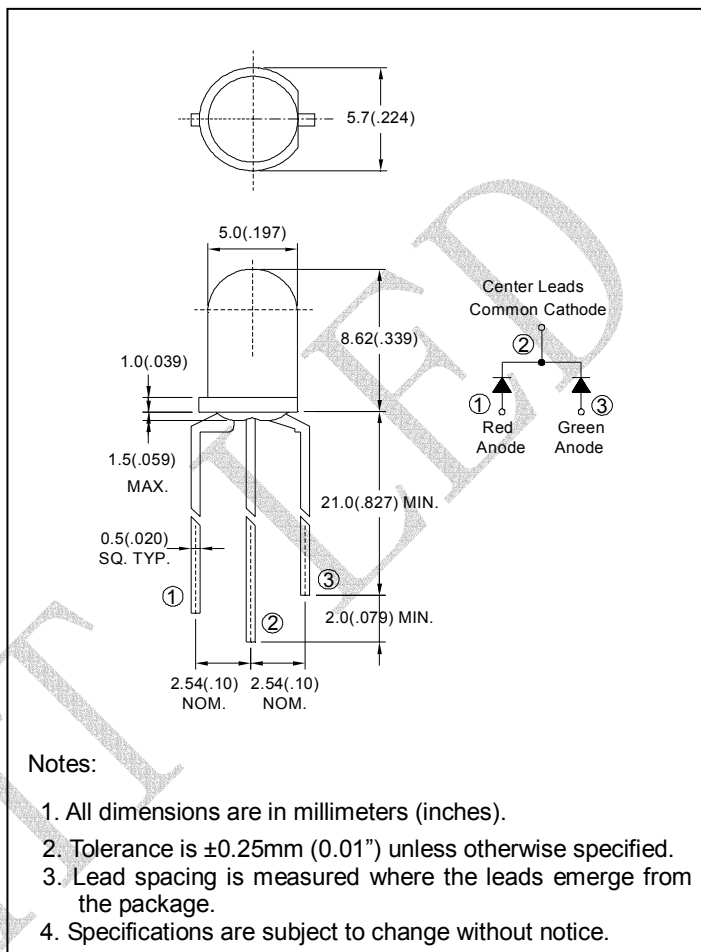
● Features:

1. Chip material: AlGaAs/GaAs (Red)
and GaP/GaP (Green)
2. Emitted color : Super Red and Green
3. Lens Appearance : White Diffused
4. Low power consumption.
5. High efficiency.
6. Versatile mounting on P.C. Board or panel.
7. Low current requirement.
8. 5mm diameter package.
9. This product don't contained restriction substance, compliance RoHS standard.

● Applications:

1. TV set
2. Monitor
3. Telephone
4. Computer
5. Circuit board

● Package dimensions



● Absolute Maximum Ratings(Ta=25°C)

| Parameter | Symbol | Super Red | Green | Unit |
|------------------------------------|-----------------|------------|-------|------|
| Power Dissipation | Pd | 80 | 80 | mW |
| Forward Current | I _F | 30 | 30 | mA |
| Peak Forward Current* ¹ | I _{FP} | 150 | 150 | mA |
| Reverse Voltage | V _R | 5 | | V |
| Operating Temperature | Topr | -40°C~85°C | | |
| Storage Temperature | Tstg | -40°C~85°C | | |

*¹Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width.

● Electrical and optical characteristics(Ta=25°C)

| Parameter | Symbol | Condition | Color | Min. | Typ. | Max. | Unit |
|--------------------------|-----------------|-------------------|--------------|------------|------------|------------|---------------|
| Forward Voltage | V_F | $I_F=20\text{mA}$ | Red Green | - | 1.8 2.2 | 2.6 2.6 | V |
| Luminous Intensity | I_V | $I_F=20\text{mA}$ | Red Green | - | 50 45 | - | mcd |
| Reverse Current | I_R | $V_R=5\text{V}$ | Red Green | - | - | 100 | μA |
| Peak Wave Length | λ_p | $I_F=20\text{mA}$ | Red Green | - | 660 568 | - | nm |
| Dominant Wave Length | λ_d | $I_F=20\text{mA}$ | Red Green | 638 564 | - | 648 574 | nm |
| Spectral Line Half-width | $\Delta\lambda$ | $I_F=20\text{mA}$ | Red Green | - | 20 30 | - | nm |
| Viewing Angle | $2\theta_{1/2}$ | $I_F=20\text{mA}$ | Red Green | - | 50 | - | deg |

● Typical Electro-Optical Characteristics Curves

Fig.1 Relative intensity vs. Wavelength

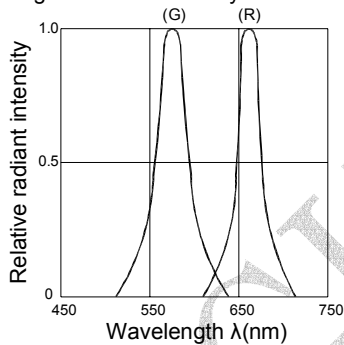


Fig.2 Forward current derating curve vs. Ambient temperature

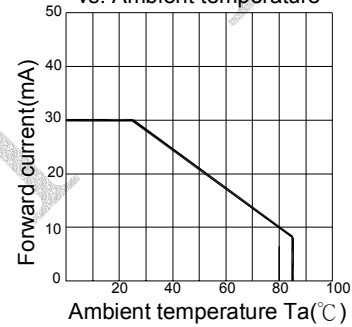


Fig.3 Forward current vs. Forward voltage

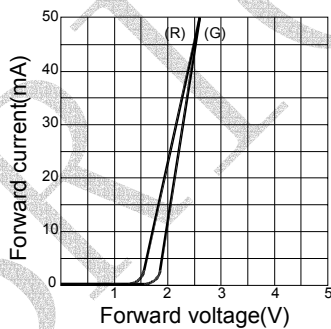


Fig.4 Relative luminous intensity vs. Ambient temperature

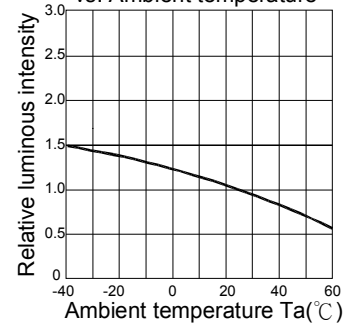


Fig.5 Relative luminous intensity vs. Forward current

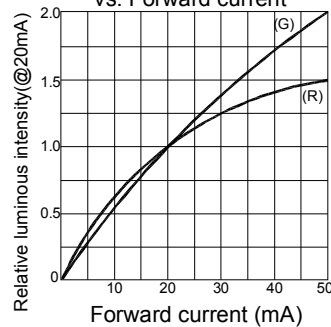
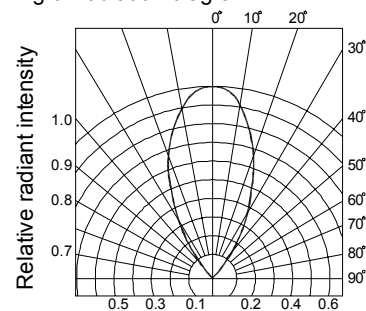


Fig.6 Radiation diagram



● Reliability Test

| Classification | Test Item | Reference Standard | Test Conditions | Result |
|--------------------|--|---|--|--------|
| Endurance Test | Operation Life | MIL-STD-750:1026 MIL-STD-883:1005 JIS-C-7021 :B-1 | I _F =20mA Ta=+25°C±5°C Test time=1,000hrs | 0/32 |
| | High Temperature High Humidity Storage | MIL-STD-202:103B JIS-C-7021 :B-11 | Ta=+85°C±5°C RH=90%-95% Test time=240hrs | 0/32 |
| | High Temperature Storage | MIL-STD-883:1008 JIS-C-7021 :B-10 | High Ta=+85°C±5°C Test time=1,000hrs | 0/32 |
| | Low Temperature Storage | JIS-C-7021 :B-12 | Low Ta=-45°C±5°C Test time=1,000hrs | 0/32 |
| Environmental Test | Temperature Cycling | MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS-C-7021 :A-4 | Ta: +85°C (30min) ~ +25°C (5min) ~ -45°C (30min) ~ +25°C (5min) Test Time : 70min/ctcle 10cycle | 0/32 |
| | Thermal Shock | MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011 | -45°C±5°C ~+85°C±5°C 20min 20min Test Time=10cycle | 0/32 |
| | Solder Resistance | MIL-STD-202:201A MIL-STD-750:2031 JIS-C-7021 :A-1 | Preheating : 120°C, within 120-180 sec. Operation heating : 255°C±5°C within 5 sec. 260°C (Max) | 0/32 |
| | Solderability | MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 JIS C 7021:A-2 | T.sol=230±5°C Dwell Time=5±1secs | 0/32 |

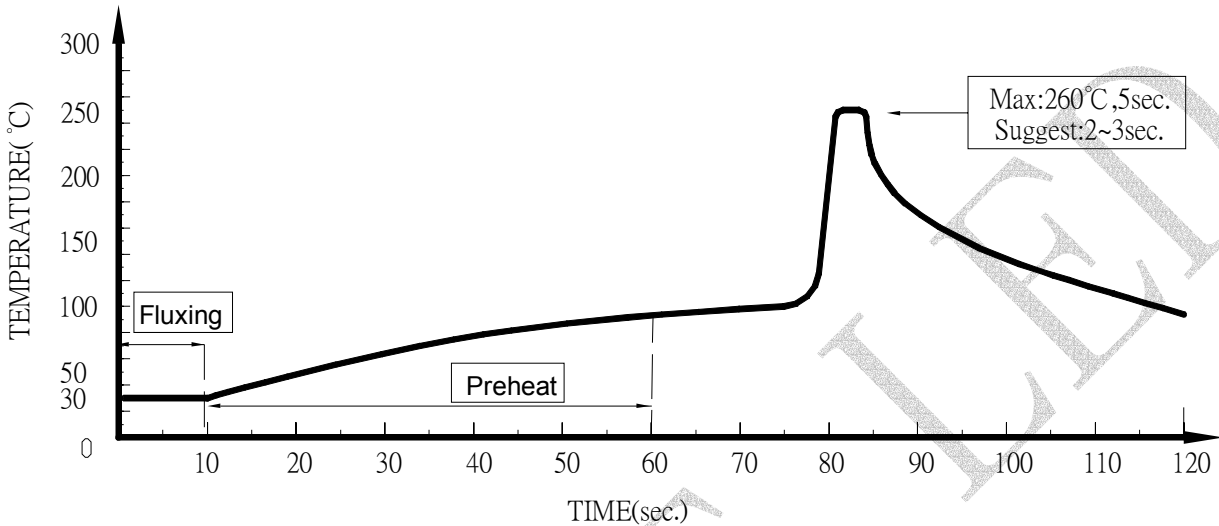
● Judgment criteria of failure for the reliability

| Measuring items | Symbol | Measuring conditions | Judgment criteria for failure |
|--------------------|-----------------------|----------------------|-------------------------------|
| Forward voltage | V _F (V) | I _F =20mA | Over U ¹ x1.2 |
| Reverse current | I _R (uA) | V _R =5V | Over U ¹ x2 |
| Luminous intensity | I _v (mcd) | I _F =20mA | Below S ¹ X0.5 |

Note: 1. U means the upper limit of specified characteristics. S means initial value.

2. Measurement shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.

● Dip Soldering



1. Please avoid any external stress applied to the lead-frames and epoxy while the LEDs are at high temperature, especially during soldering
2. DIP soldering and hand soldering should not be done more than one time.
3. After soldering, avoid the epoxy lens from mechanical shock or vibration until the LEDs are back to room temperature.
4. Avoid rapid cooling during temperature ramp-down process
5. Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs

● IRON Soldering

300°C Within 3 sec., One time only.